



PRODUCT SUMMARY

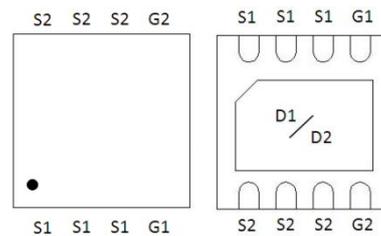
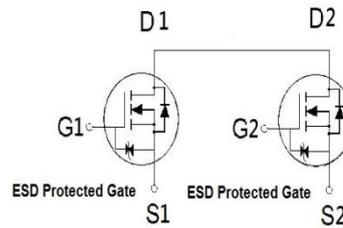
| | | |
|---------------|--------------|-------|
| $V_{(BR)DSS}$ | $R_{DS(ON)}$ | I_D |
| 20V | 6mΩ | 55A |

Features

- Patent Pending.
- Pb-Free, Halogen Free and RoHS compliant.
- Low $R_{DS(on)}$ to Minimize Conduction Losses.
- Ohmic Region Good $R_{DS(on)}$ Ratio.
- Optimized Gate Charge to Minimize Switching Losses.
- Products Integrated ESD diode with ESD Protected up to 2KV.

Applications

- Protection Circuits Applications.
- Portable Devices for Battery PACK Applications.



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ °C}$ Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS | | SYMBOL | LIMITS | UNITS |
|--|-----------------------|----------------|------------|-------|
| Drain-Source Voltage | | V_{DS} | 20 | V |
| Gate-Source Voltage | | V_{GS} | ±8 | V |
| Continuous Drain Current ² | $T_C = 25\text{ °C}$ | I_D | 55 | A |
| | $T_C = 100\text{ °C}$ | | 35 | |
| | $T_A = 25\text{ °C}$ | | 19 | |
| | $T_A = 70\text{ °C}$ | | 15 | |
| Pulsed Drain Current ¹ | | I_{DM} | 100 | |
| Avalanche Current | | I_{AS} | 32 | |
| Avalanche Energy | L = 0.1mH | E_{AS} | 51 | mJ |
| Power Dissipation | $T_C = 25\text{ °C}$ | P_D | 31 | W |
| | $T_C = 100\text{ °C}$ | | 12.5 | |
| | $T_A = 25\text{ °C}$ | | 3.6 | |
| | $T_A = 70\text{ °C}$ | | 2.3 | |
| Operating Junction & Storage Temperature Range | | T_j, T_{stg} | -55 to 150 | °C |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE | SYMBOL | TYPICAL | MAXIMUM | UNITS |
|----------------------------------|-----------------|---------|---------|-------|
| Junction-to-Ambient ³ | $R_{\theta JA}$ | | 35 | °C/W |
| Junction-to-case | $R_{\theta JC}$ | | 4 | |

¹Pulse width limited by maximum junction temperature.

²Package limitation current is 18A.

³The value of $R_{\theta JA}$ is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25\text{ °C}$.

ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

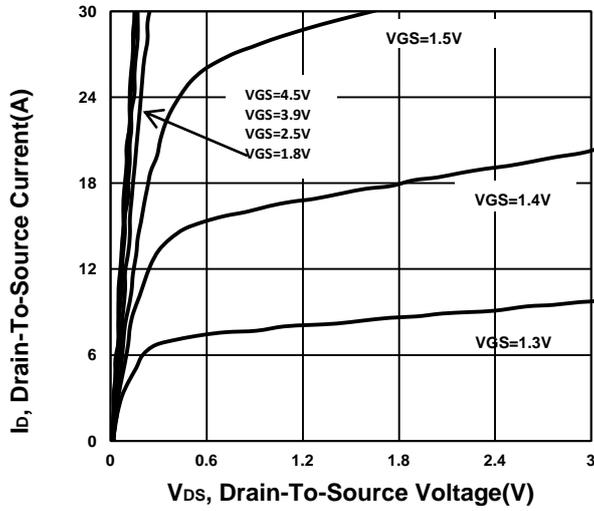
| PARAMETER | SYMBOL | TEST CONDITIONS | LIMITS | | | UNIT | | |
|---|--------------------------|--|--|------|------|------|----|----|
| | | | MIN | TYP | MAX | | | |
| STATIC | | | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | V _{GS} = 0V, I _D = 250μA | 20 | | | V | | |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250μA | 0.4 | 0.7 | 1 | | | |
| Gate-Body Leakage | I _{GSS} | V _{DS} = 0V, V _{GS} = ±8V | | | ±10 | uA | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 16V, V _{GS} = 0V | | | 1 | uA | | |
| | | V _{DS} = 10V, V _{GS} = 0V, T _J = 125 °C | | | 10 | | | |
| Drain-Source On-State Resistance ¹ | R _{DS(ON)} | V _{GS} = 4.5V, I _D = 3A | 3.5 | 5 | 6 | mΩ | | |
| | | V _{GS} = 3.8V, I _D = 3A | 3.7 | 5.2 | 7.2 | | | |
| | | V _{GS} = 3.1V, I _D = 3A | 4 | 5.6 | 7.8 | | | |
| | | V _{GS} = 2.5V, I _D = 3A | 4.3 | 5.8 | 8 | | | |
| | | V _{GS} = 1.8V, I _D = 3A | 5 | 8.7 | 12 | | | |
| Forward Transconductance ¹ | g _{fs} | V _{DS} = 5V, I _D = 3A | | 43 | | S | | |
| DYNAMIC | | | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} = 0V, V _{DS} = 10V, f = 1MHz | | 2111 | | pF | | |
| Output Capacitance | C _{oss} | | | 320 | | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 282 | | | | |
| Gate Resistance | R _g | V _{GS} = 0V, V _{DS} = 0V, f = 1MHz | | 1.7 | | Ω | | |
| Total Gate Charge ² | Q _{g(VGS=4.5V)} | V _{DS} = 10V, I _D = 3A | | 29 | | nC | | |
| | Q _{g(VGS=3.9V)} | | | 25.5 | | | | |
| Gate-Source Charge ² | Q _{gs} | | | 2.5 | | | | |
| Gate-Drain Charge ² | Q _{gd} | | | 7.3 | | | | |
| Turn-On Delay Time ² | t _{d(on)} | | V _{DD} = 15V I _D ≅ 3A, V _{GEN} = 4.5V, R _G = 6Ω | | 20 | | | nS |
| Rise Time ² | t _r | | | | 40 | | | |
| Turn-Off Delay Time ² | t _{d(off)} | | | 72 | | | | |
| Fall Time ² | t _f | | | 18 | | | | |
| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C) | | | | | | | | |
| Continuous Current ³ | I _S | | | | 25.8 | A | | |
| Forward Voltage ¹ | V _{SD} | I _F = 3A, V _{GS} = 0V | | | 1.2 | V | | |
| Reverse Recovery Time | t _{rr} | I _F = 3A , dI _F /dt = 100A / μS | | 21 | | nS | | |
| Reverse Recovery Charge | Q _{rr} | | | | 8 | | nC | |

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

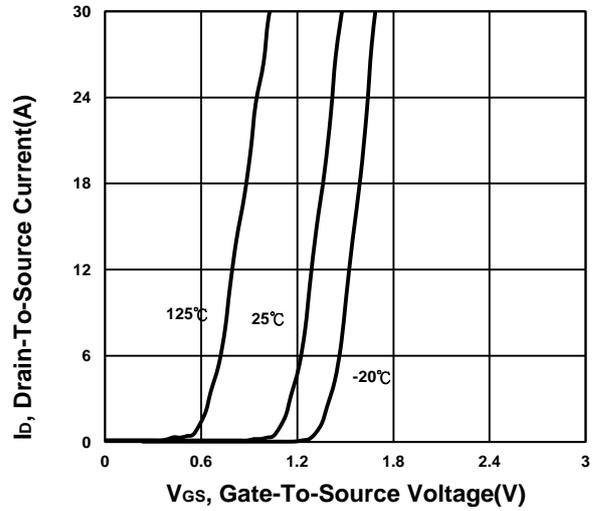
²Independent of operating temperature.

³Package limitation current is 18A.

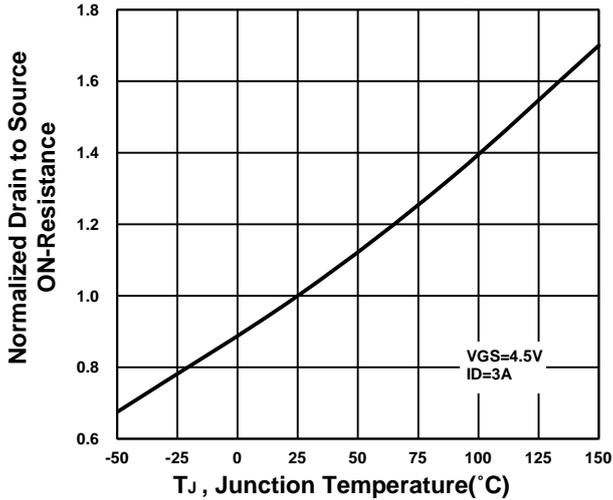
Output Characteristics



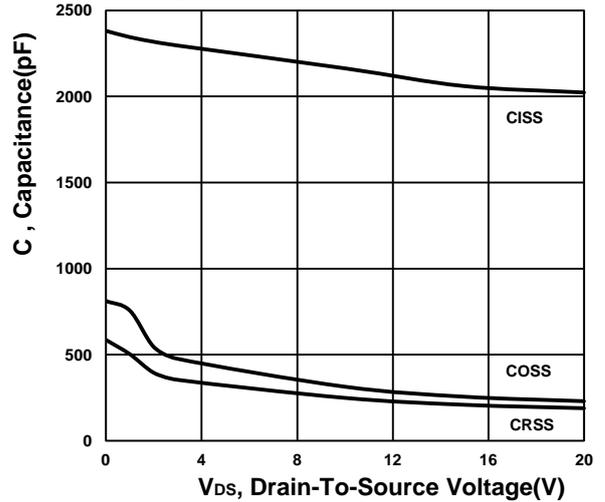
Transfer Characteristics



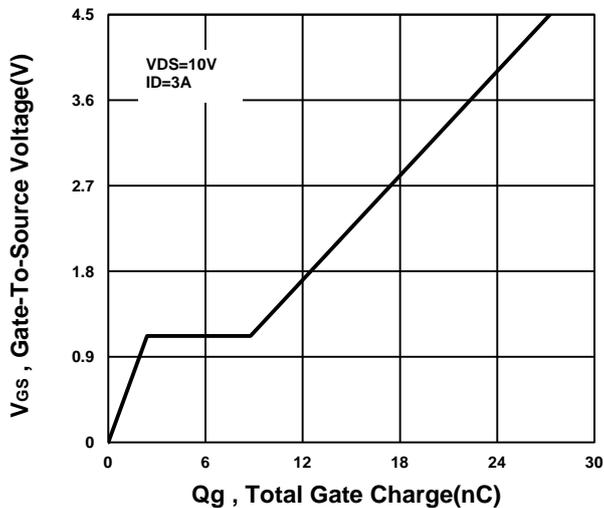
On-Resistance VS Temperature



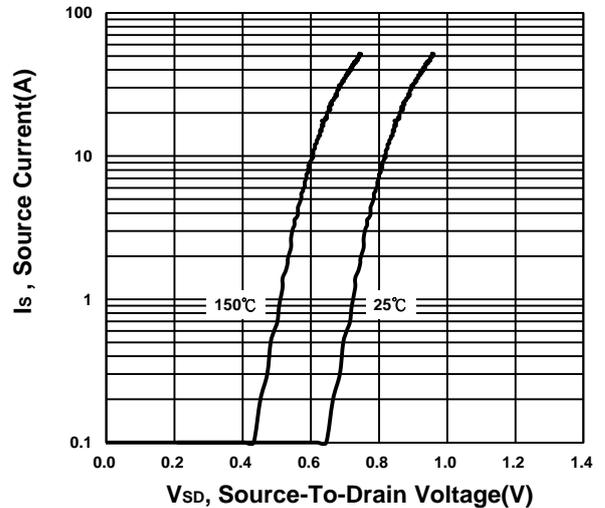
Capacitance Characteristic



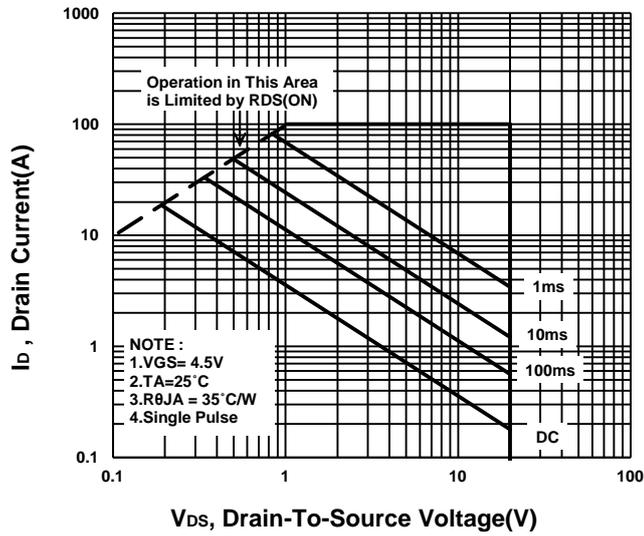
Gate charge Characteristics



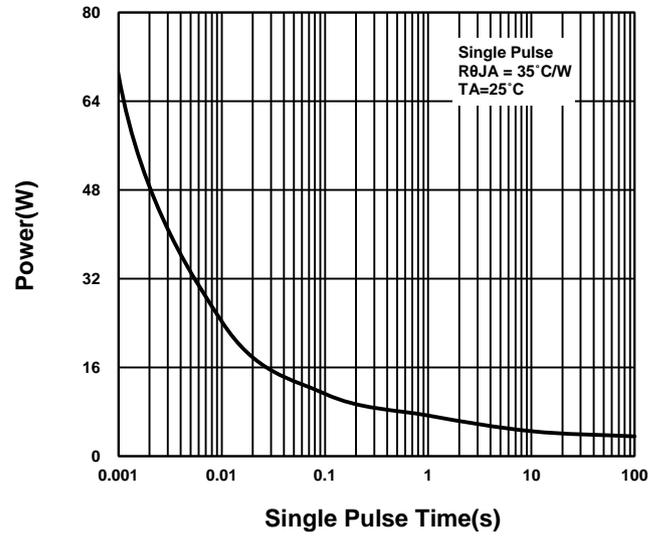
Source-Drain Diode Forward Voltage



Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

